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- 3. 5,724,292, Mar. 3, 1998, Static Semiconductor memory device; Tomohisa Wada, 365/207, 154, 189.01, 205 [IMAGE AVAILABLE]
- 4. 5,717,636, Feb. 10, 1998, EEPROM memory with contactless memory cells; Marco Dallabora, et al., 365/185.13, 185.06, 185.11 [IMAGE AVAILABLE]
- 5. 5,699,308, Dec. 16, 1997, Semiconductor memory device having two layers of bit lines arranged crossing with each other; Tomohisa Wada, et al., 365/200, 51, 63 [IMAGE AVAILABLE]
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